



ASSEMBLY NOTES:

Built on PMP10143 Rev_A PWB
 "DNP" = "Do Not Populate"

NOTES:

- Protected against short circuit < 3sec.
- Use PTC on outputs for continuous short protection
- The board has been tested @ ambient temperature $T_a = +25^\circ\text{C}$ and can work up to $T_a = +85^\circ\text{C}$
- To extend the ambient temperature to -40°C , Use $L_p = 6\text{mH}$ version of transformer T1 by adding 0.1mm gap on the actual version

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Designed for: Public Release		Mod. Date: 23.06.2015	
Project Title: Isolated universal line to 3.3V@0.4A & 12V@30mA			
Sheet Title: Isolated universal line to 3.3V@0.4A & 12V@30mA			
Number: PMP10143		Rev: B	
SVN Rev: Version control disabled		Assembly Variant: [No Variations]	
Drawn By:		File: PMP10143 Rev_B Schematic_SchDoc	
Engineer: R. Scibilia		Contact: http://www.ti.com/support	
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